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(12)

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Xie

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(54) HEADSET

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(*) Notice: This patent is subject to a terminal disclaimer.

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D29/112; 2/209, 423; 381/380, 381,
381/374; 345/7-9; 362/105, 86;
455/90.3, 575.1, 569.1
CPC H04R 25/00; H04R 25/01; H04R 1/1066;
H04R 1/1016; H04R 5/033; H04R
5/0335; H04R 1/105; H04R 1/1058;
H04R 19/04; H04R 11/104; H04R
1/1091; G02B 27/017; F21V 21/084
See application file for complete search history.

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Massand, PLLC

(57) CLAIM

The ornamental design for a headset, as shown and described.

DESCRIPTION

FIG. 1 is a front, right side, top perspective view of a headset showing my new design;
FIG. 2 is a rear, left side, bottom perspective view thereof;
FIG. 3 is a front elevational view thereof;
FIG. 4 is a rear elevational view thereof;
FIG. 5 is a left side elevational view thereof;
FIG. 6 is a right side elevational view thereof;
FIG. 7 is a top plan view thereof; and,
FIG. 8 is a bottom plan view thereof.
The broken lines depict portions of the headset that form no part of the claimed design.

1 Claim, 8 Drawing Sheets



(56)

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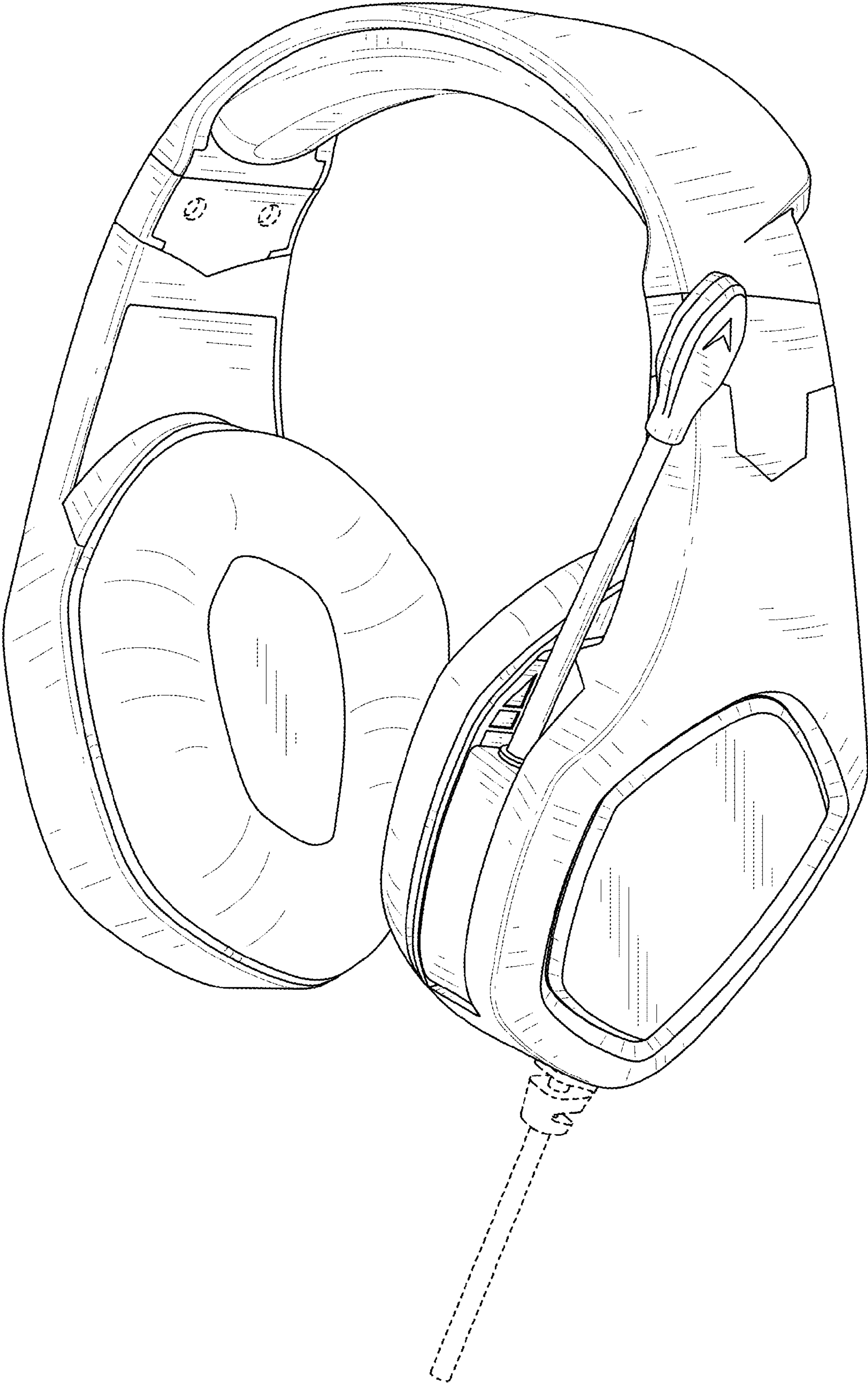


FIG. 1

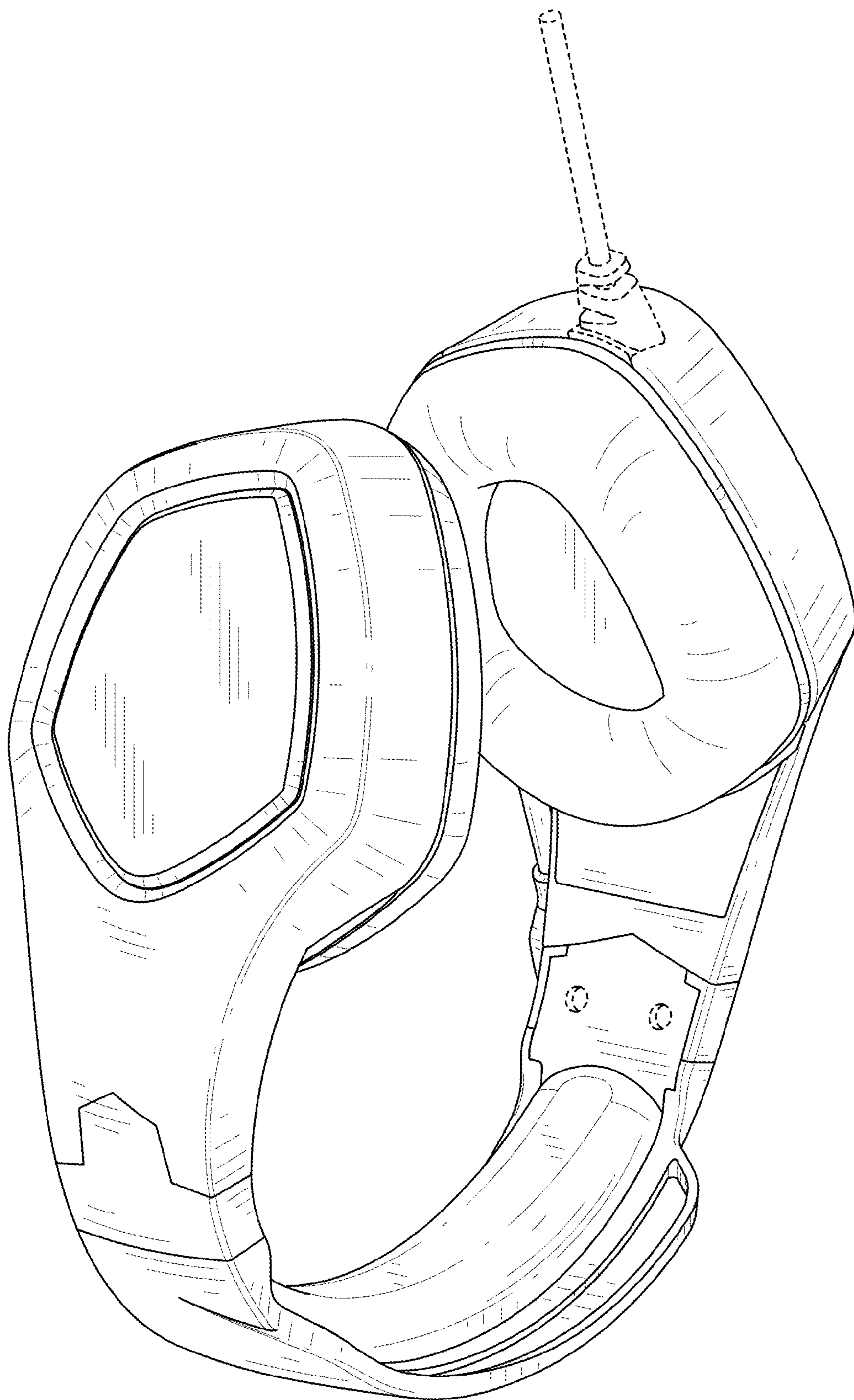


FIG. 2

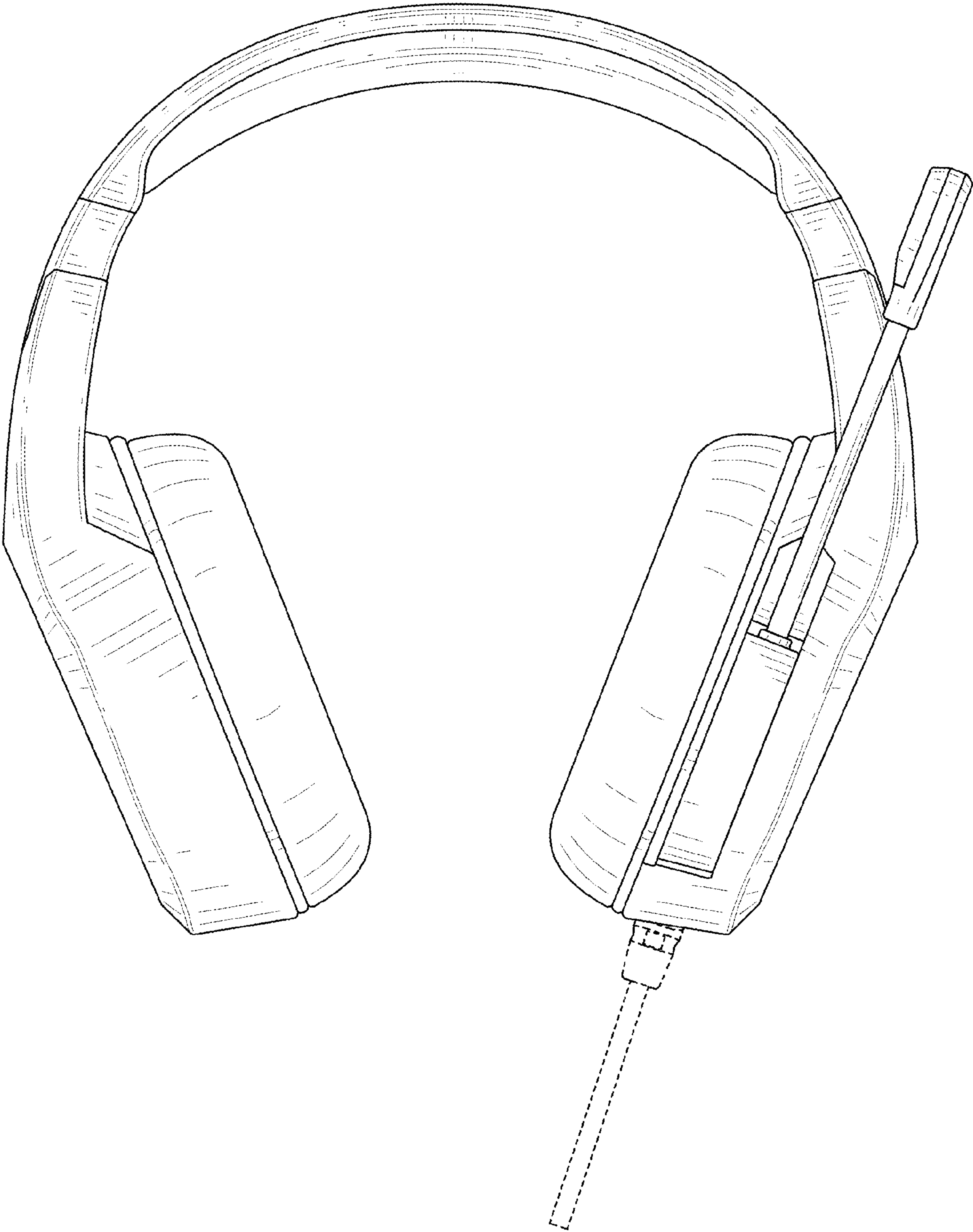


FIG. 3

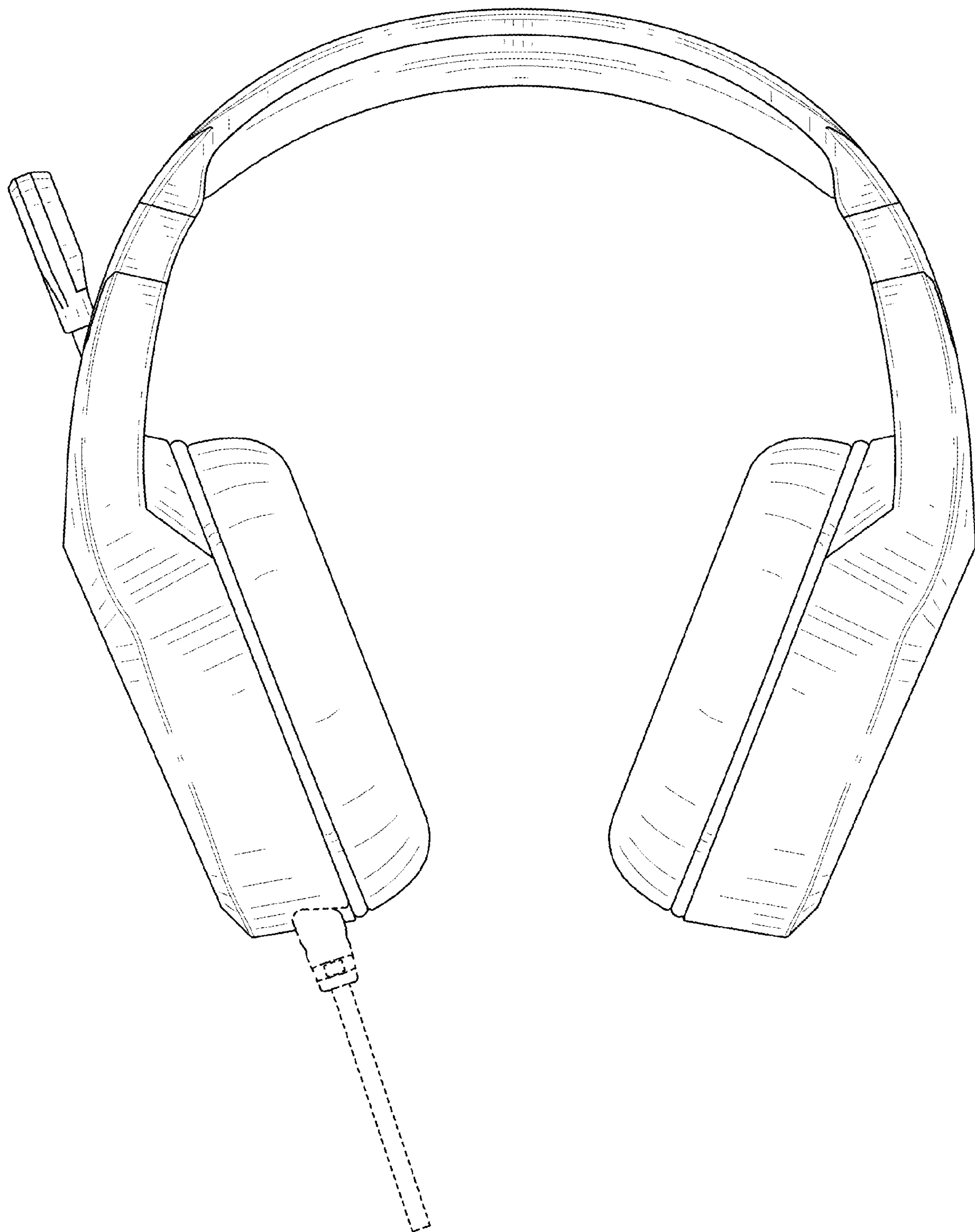


FIG. 4

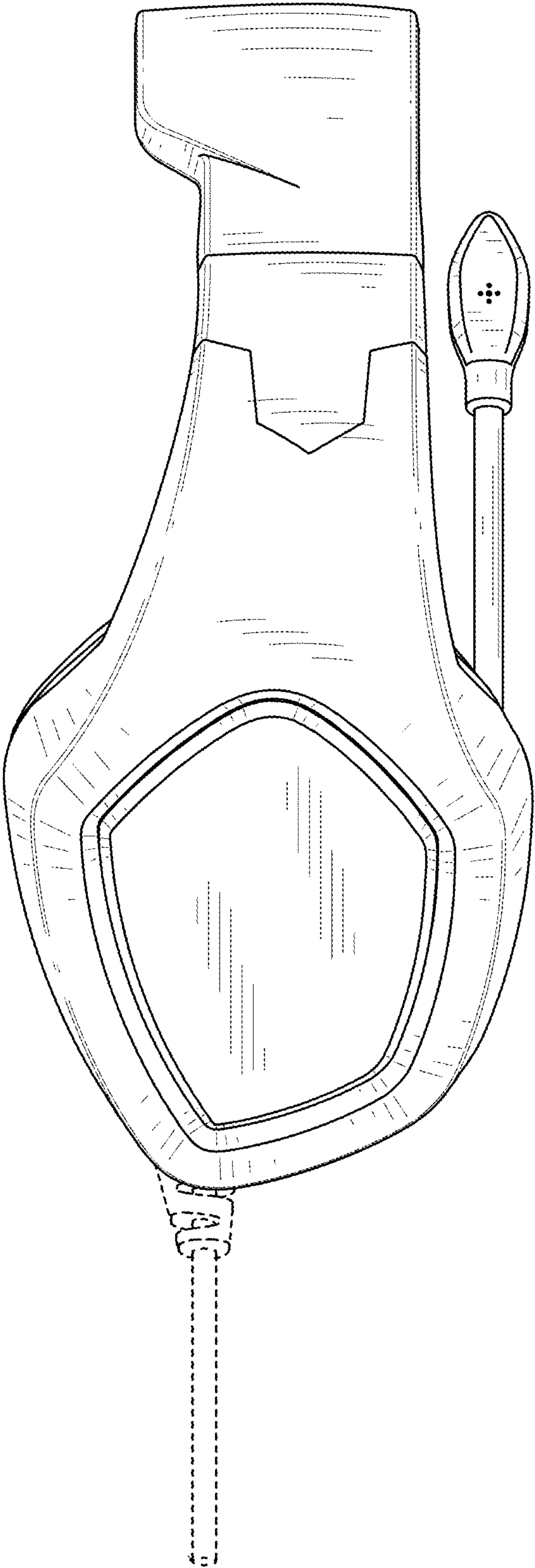


FIG. 5

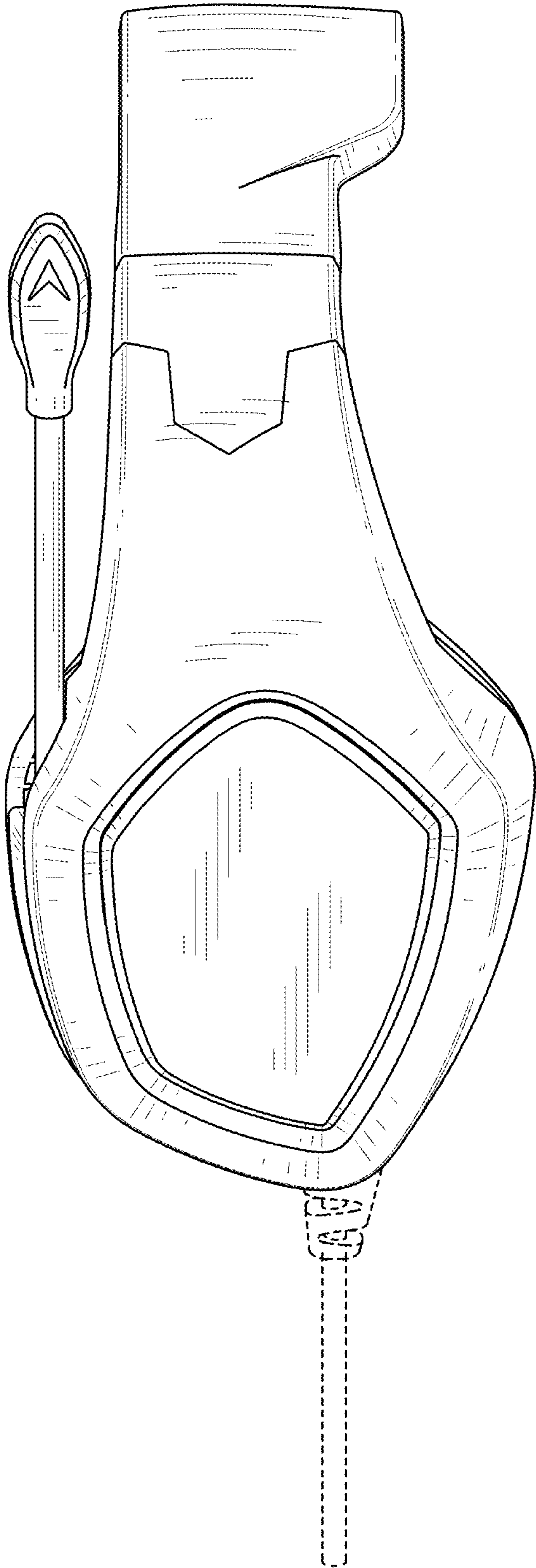


FIG. 6

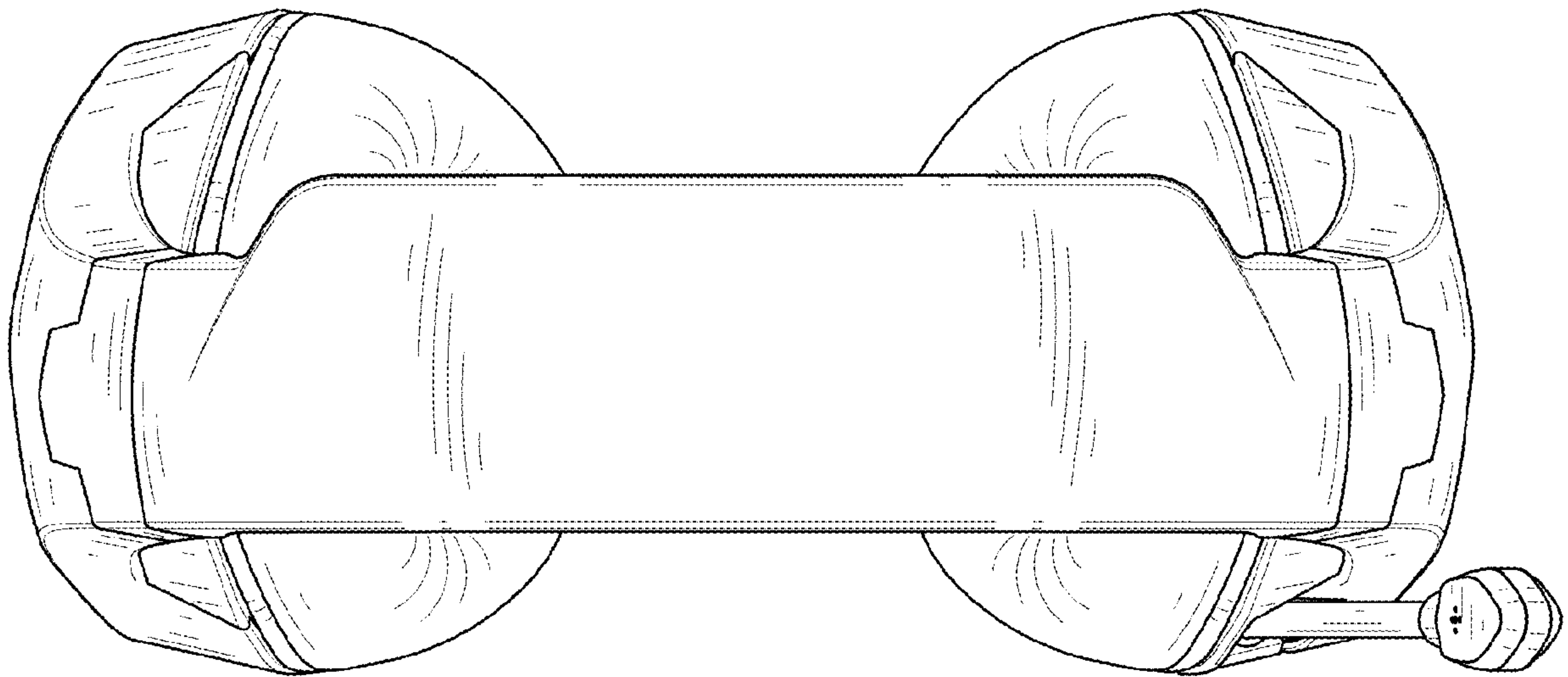


FIG. 7

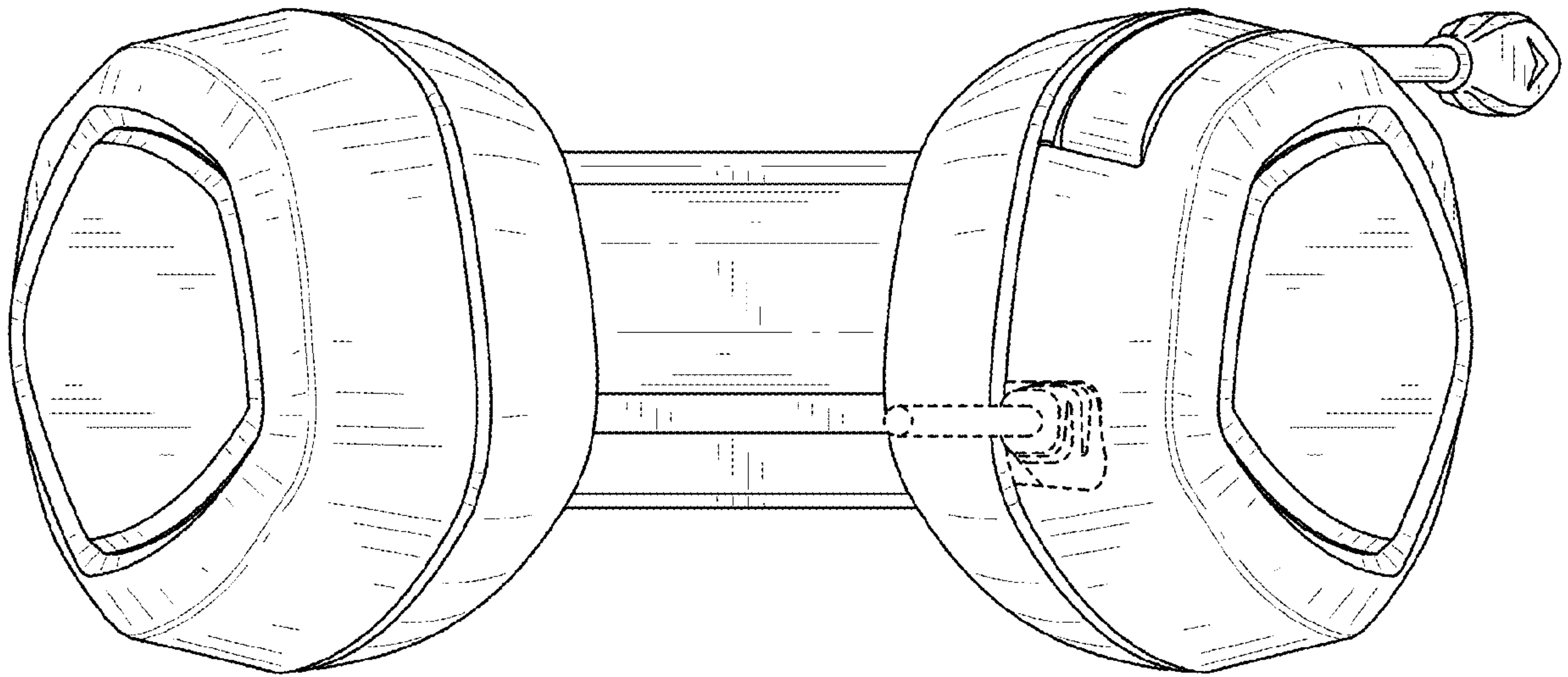


FIG. 8